KEMET Part Number: C0603X103J3GACTU

(C0603X103J3GAC7867)



SMD Comm C0G Flex, Ceramic, 0.01 uF, 5%, 25 VDC, C0G, SMD, MLCC, FT-CAP, Ultra-Stable, 0603



Dimensions		
Chip Size	0603	
L	1.6mm +/-0.17mm	
W	0.8mm +/-0.15mm	
Т	0.8mm +/-0.15mm	
S	0.58mm MIN	
В	0.45mm +/-0.15mm	

Packaging Specifications		
Packaging:	T&R, 180mm, Paper Tape	
Packaging Quantity:	4000	

General Information		
Series:	SMD Comm C0G Flex	
Style:	SMD Chip	
Description:	SMD, MLCC, FT-CAP, Ultra- Stable	
Features:	FT-CAP, Ultra-Stable	
RoHS:	Yes	
Termination:	Flexible Termination	
Marking:	No	
AEC-Q200:	No	
Shelf Life:	78 Weeks	
MSL:	1	

Specifications		
Capacitance:	0.01 uF	
Measurement Condition:	1 kHz 1.0Vrms	
Capacitance Tolerance:	5%	
Voltage DC:	25 VDC	
Dielectric Withstanding Voltage:	62.5 VDC	
Temperature Range:	-55/+125°C	
Temperature Coefficient:	COG	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1kHz 1.0Vrms	
Dissipation Factor:	0.1% 1 kHz 1.0Vrms	
Aging Rate:	0% Loss/Decade Hour	
Insulation Resistance:	100 GOhms	

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